COBP PHOTO REFLECTOR

GENERAL DESCRIPTION

NJL5901AR is the compact surface mount type photo reflector in which Lead(Pb) – free reflow soldering is possible. It is possible to perform reflow soldering temperature 260°C and 2 times. NJL5901R has realized the high output current and the high S/N ratio combining a high output infrared LED and a high sensitivity Si photo-transister.

■ FEATURES

- Pb free solder re-flowing permitted(260°C, 2times)
- \bullet Miniature, thin, surface mount 1.6mm \times 2.4mm \times 0.8mm
- Built-in visible light cut-off filter
- High output, high S/N ratio

■ APPLICATIONS

- Detecting the location of CD/DVD optical pickup head
- Detecting the location of lens for DSC and Cellular Phone's camera module
- End detection of VCR tape
- Rotation detection of various motors



■ ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

PARAMETER	SYMBOL	RATINGS	UNIT		
Emitter					
Forward Current (Continuous)	lF	30	mA		
Reverse Voltage (Continuous)	VR	6	V		
Power Dissipation	PD	45	mW		
Detector					
Collector-Emitter Voltage	VCEO	16	V		
Emitter-Collector Voltage	VECO	6	V		
Collector Current	IC	10	mA		
Collector Power Dissipation	PC	25	mW		
Coupled					
Total Power Dissipation	Ptot	60	mW		
Operating Temperature	Topr	-20 to +85	°C		
Storage Temperature	Tstg	-40 to +85	°C		
Reflow Soldering Temperature	Tsol	260	°C		

■ ELECTRO-OPTICAL CHARACTERISTICS (Ta=25°C)

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Emitter						
Forward Voltage	VF	IF=4mA	0.9	—	1.3	V
Reverse Current	IR	VR=6V	—	—	10	μA
Capacitance	Ct	VR=0V,f=1MHz	—	25	—	pF
Detector						
Dark Current	ICEO	VCE=10V	—	—	0.2	μA
Collector-Emitter Voltage	VCEO	IC=100μA	16	_	_	V
Coupled						
Output Current	lo	IF=4mA,VCE=2V,d=0.7mm	180	—	450	μA
Operating Dark Current *1	ICEOD	IF=4mA,VCE=2V	_	—	2	μA
Rise Time	tr	IO=100μA,VCE=2V,RL=1KΩ,d=0.7mm	_	30	—	μS
Fall Time	tf	IO=100μA,VCE=2V,RL=1KΩ,d=0.7mm		30	_	μS

*1 lcoed may increase according to the periphery situation of the surface mounted product.

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DARK CURRENT TEST CONDITION

The infrared signal from LED is reflected at the aluminum surface.

■ OUTPUT CURRENT TEST CONDITION





RESPONSE TIME TEST CONDITION





■ EDGE RESPONSE TEST CONDITION



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Power Dissipation vs. Temperature



TYPICAL CHARACTERISTICS











Forward Voltage vs. Temperature



Operating Dark Current vs. Temperature



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Vce Saturation (Ta=25°C)



Output Current vs. Edge Distance (Ta=25°C)



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Spectral Response (Ta=25°C)

PRECAUTION FOR HANDLING

1. Soldering to actual circuit board

Soldering condition

The surface temperature of plastic package is lower than 260 °C.

Soldering Method

1) Reflow Method

Soldering to be done within twice under the recommended condition mentioned below



a : Temperature ramping rate	: 1 to 4°C/s			
b : Pre-heating temperature time	: 150 to 180°C : 60 to 120s			
c : Temperature ramping rate	: 1 to 4°C /s			
d : 220°C or higher time	: Shorter than 60s			
e : 230°C or higher time	: Shorter than 40s			
f : Peak temperature	: Lower than 260°C			
g : Temperature ramping rate	: 1 to 6°C /s			
The temperature of the surface of mold package				

2) Reflow Method (In case of infrared heating)

The temperature profile is same as the above

Avoid direct irradiation to the plastic package because it may absorb the Infrared Radiation and its surface temperature will be higher than the lead.

3) The other method

Avoid rapid heating up like dipping the devices directly into the melting solder or vapor phase method (VPS).

Solder the device in short time as soon as possible. If the device is heated and kept in high temperature for longer time, its reliability would be affected.

2. Cleaning

Avoid washing the device after soldering by reflow method.

3. Attention in handling

- 1) Treat not to touch the lens surface.
- 2) Avoid dust and any other foreign materials on the lens surface such as paint, bonding material, etc.
- Never to apply reverse voltage (V_{EC}) of more than 6V on the photo transistor when measuring the characteristics or adjusting the system. If applied, it causes to lower the sensitivity.
- 4) When mounting, special care has to be taken on the mounting position and tilting of the device because it is very important to place the device to the optimum position to the object.

4. Storage

Mount the device as soon as possible after opening the envelope. In order to prevent from degradation by the moisture at the reflow process, the device is contained in deaeration packaging.

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NJL5901AR Taping Specification

(TE1)

1. Taping Size

- 1) Carrier tape is used with polycarbonate.
- 2) Cover tape is used with electro statistically prevention treated Polyester type tape.
- 3) Product taping direction is to place the index mark against the pull out direction of the tape as in the drawing.



2. Taping Strength

Pull up the cover tape from the carrier tape, and when the opening angle comes around 10 to 15°, and the peeling-off strength is to be within the power of 20 to 70g.

3. Packaging

- 1) The taped products are to be rolled up on the taping reel as on the drawing.
- 2) Rolling up specification
 - 2-1) Start rolling : Carrier tape open space more than 20 Pieces.

2-2) End of rolling : Carrier tape open space more than 20 Pieces, and 2 round of reel space at the cover tape only.

- 3) Taping quantity : 2,000 Pieces.
- 4) Seal off after putting each reels in a damp proof bag with silica gel.

